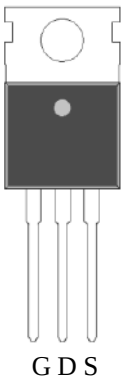
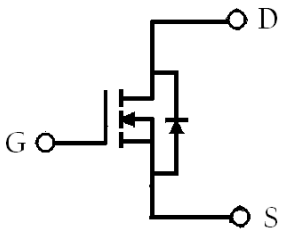
N-Channel Enhancement Mode Power MOSFET

TO-220



G D S



G：Gate D：Drain S：Source

Features:

- Low Gate Charge
- Simple Drive Requirement
- Fast Switching Characteristic
- RoHS compliant package

BV_{DSS}	500V
I_D @ V_{GS}=10V, T_C=25°C	8.5A
I_D @ V_{GS}=10V, T_C=100°C	5.4A
$R_{DSON(TYP)}$ @ V_{GS}=10V, I_D=4.5A	0.71Ω

Ordering Information

Device	Package	Shipping
KWN9N50B	TO-220 (RoHS compliant)	50 pcs/tube, 20 tubes/box, 5 boxes / carton

Absolute Maximum Ratings (T_C=25°C)

Parameter	Symbol	Limits	Unit
Drain-Source Voltage (Note 1)	V_{DS}	500	V
Gate-Source Voltage	V_{GS}	±30	
Continuous Drain Current @T_C=25°C, V_{GS}=10V	I_D	8.5*	A
Continuous Drain Current @T_C=100°C, V_{GS}=10V		5.4*	
Pulsed Drain Current @ V_{GS}=10V (Note 2)	I_{DM}	34*	
Single Pulse Avalanche Energy (Note 3)	E_{AS}	290	mJ
Avalanche Current (Note 2)	I_{AS}	8	A
Repetitive Avalanche Energy (Note 2)	E_{AR}	12.5	mJ
Maximum Temperature for Soldering @ Lead at 0.125 in(3.175mm) from case for 10 seconds	T_L	300	°C
Total Power Dissipation (T_C=25℃)	P_D	134	W
Linear Derating Factor above 25℃		1.07	W/°C
Operating Junction and Storage Temperature	Tj, Tstg	-55~+150	°C

*Drain current limited by maximum junction temperature

Note : 1. T_J=+25℃ to +150℃.
2. Repetitive rating; pulse width limited by maximum junction temperature.
3. I_{AS}=8A, V_{DD}=50V, L=5mH, R_G=25Ω, starting T_J=+25℃.

Thermal Data

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-case, max	$R_{\theta JC}$	0.93	°C/W
Thermal Resistance, Junction-to-ambient, max	$R_{\theta JA}$	62.5	

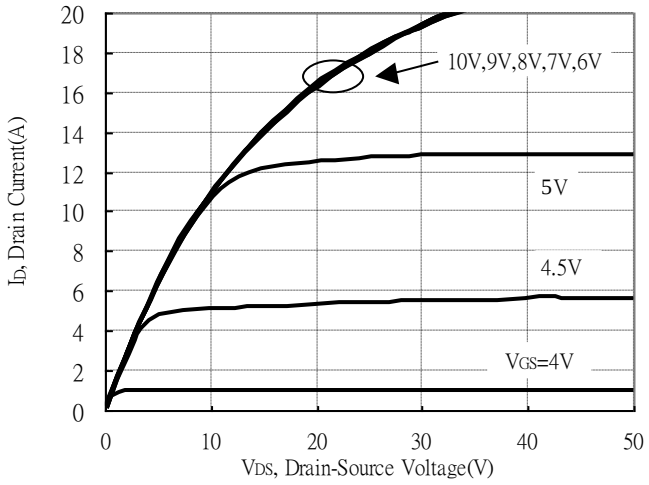
Characteristics (Tj=25°C, unless otherwise specified)

Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Static					
BV_{DSS}	500	-	-	V	V_{GS}=0V, I_D=250μA
$V_{GS(th)}$	2.0	-	4.0	V	V_{DS} = V_{GS}, I_D=250μA
*G_{FS}	-	8	-	S	V_{DS} =15V, I_D=4A
I_{GSS}	-	-	±100	nA	V_{GS}=±30V, V_{DS}=0V
I_{DSS}	-	-	1	μA	V_{DS} =400V, V_{GS} =0V
*$R_{DS(ON)}$	-	0.71	0.9	Ω	V_{GS} =10V, I_D=4.5A
Dynamic					
*Qg	-	26.4	-	nC	I_D=4.5A, V_{DD}=250V, V_{GS}=10V
*Qgs	-	4.8	-		
*Qgd	-	9.9	-		
*$t_{d(ON)}$	-	14	-	ns	V_{DD}=250V, I_D=4.5A, V_{GS}=10V, R_G=1Ω
*tr	-	8.8	-		
*$t_{d(OFF)}$	-	42.6	-		
*t_f	-	7.8	-		
Ciss	-	975	-	pF	V_{GS}=0V, V_{DS}=25V, f=1MHz
Coss	-	108	-		
Crss	-	76	-		
Source-Drain Diode					
*I_S	-	-	8	A	
*I_{SM}	-	-	32		
*V_{SD}	-	0.8	1.2	V	I_S=4.5A, V_{GS}=0V
*trr	-	242	-	ns	V_{GS}=0V, I_F=4.5, dI_F/dt=100A/μs
*Qrr	-	1.5	-	μC	

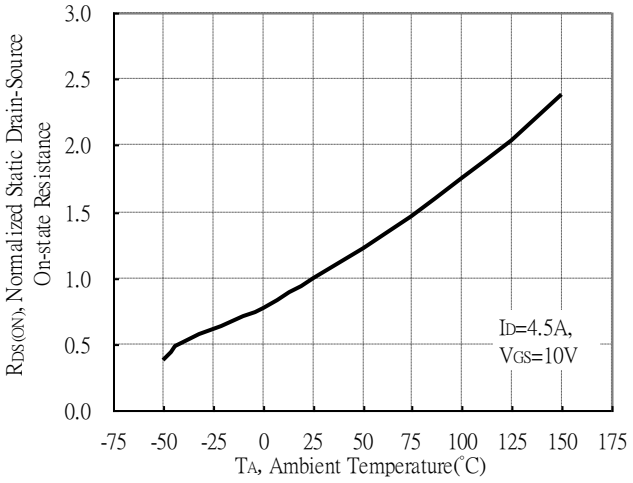
*Pulse Test : Pulse Width ≤300μs, Duty Cycle≤2%

Typical Characteristics

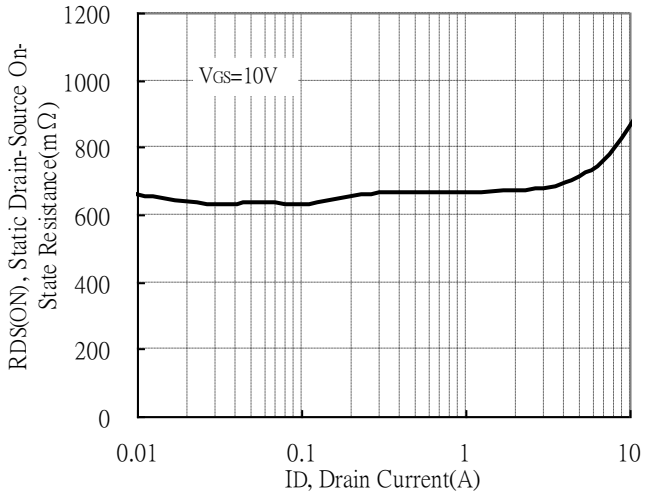
Typical Output Characteristics



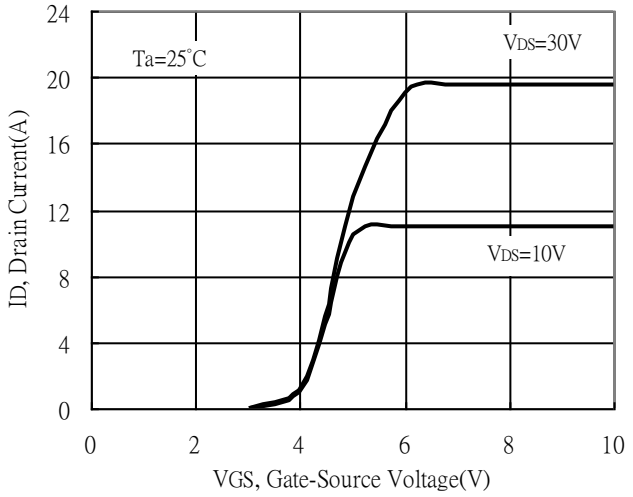
Static Drain-Source On-resistance vs Ambient Temperature



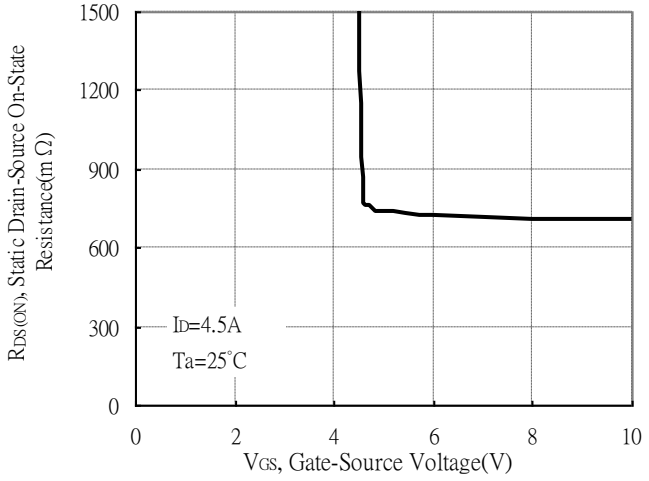
Static Drain-Source On-State resistance vs Drain Current



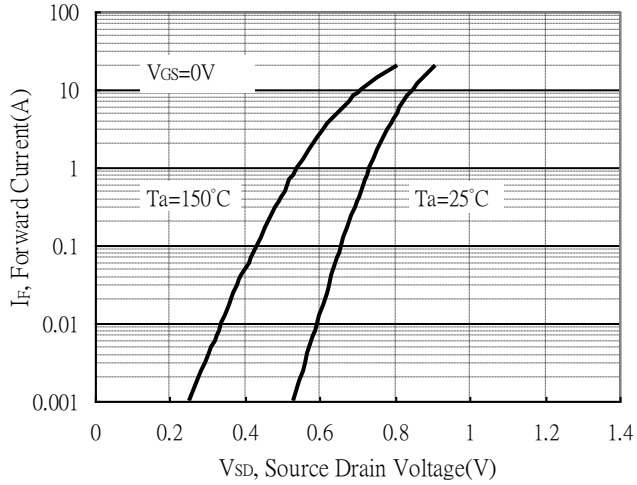
Drain Current vs Gate-Source Voltage



Static Drain-Source On-State Resistance vs Gate-Source Voltage

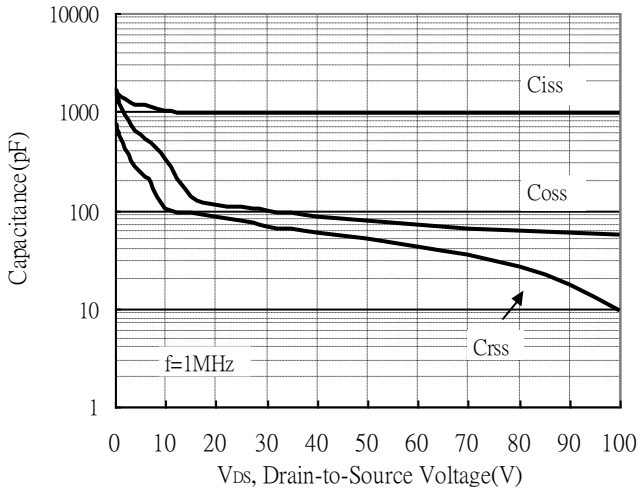


Forward Drain Current vs Source-Drain Voltage

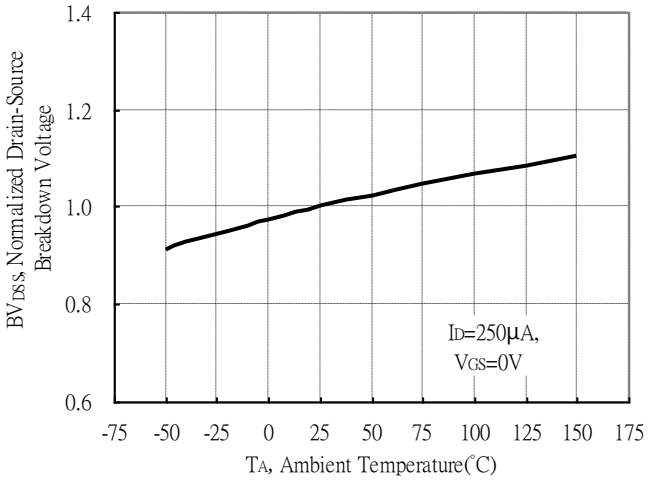


Typical Characteristics(Cont.)

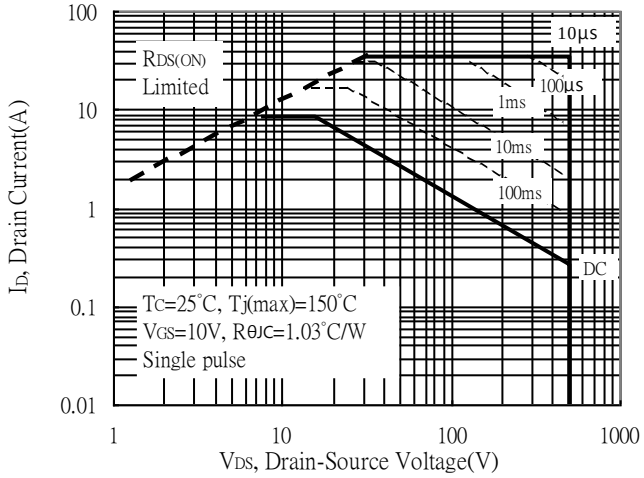
Capacitance vs Reverse Voltage



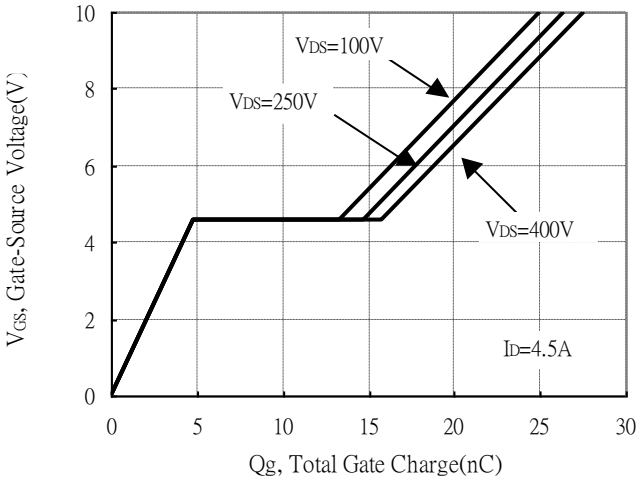
Brekdown Voltage vs Ambient Temperature



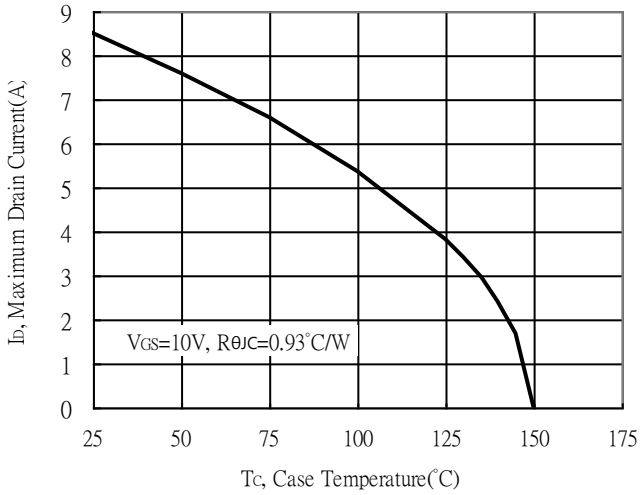
Maximum Safe Operating Area



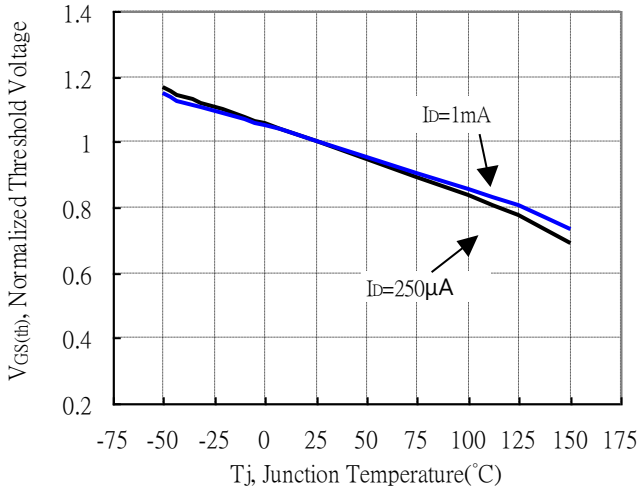
Gate Charge Characteristics



Maximum Drain Current vs Case Temperature

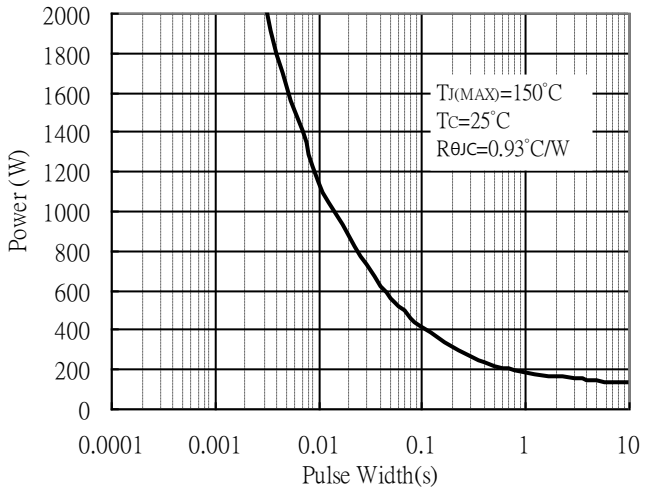


Threshold Voltage vs Junction Tempearture

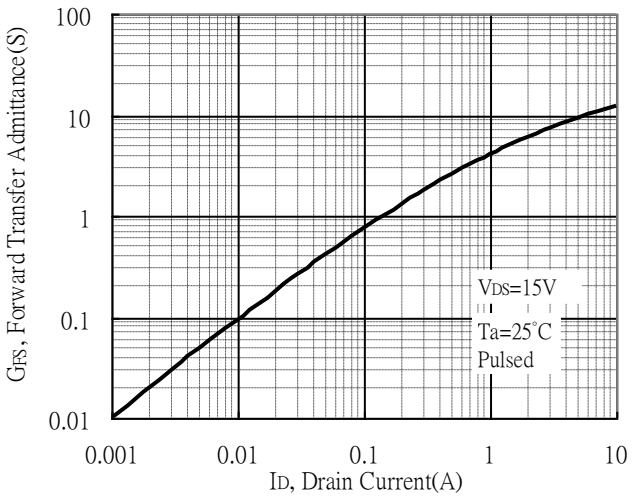


Typical Characteristics(Cont.)

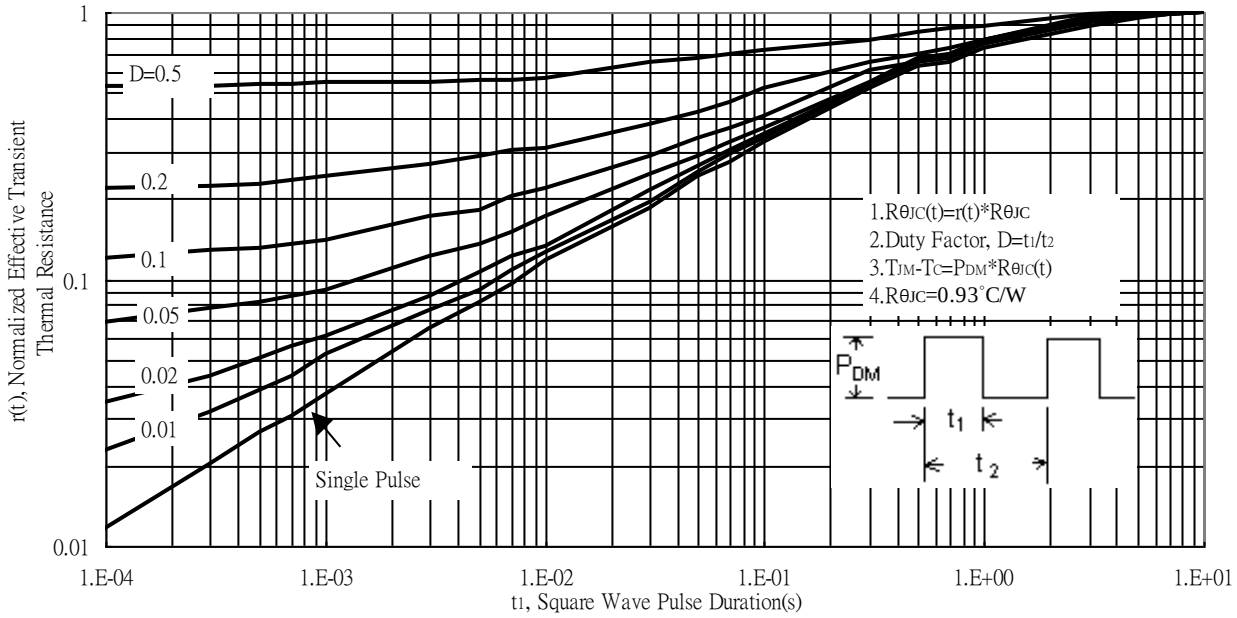
Single Pulse Power Rating, Junction to Case



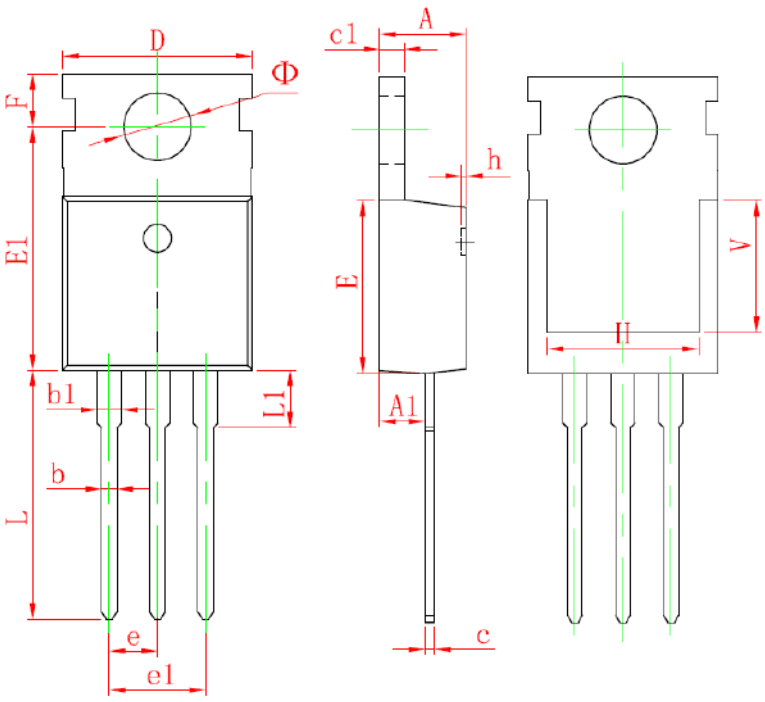
Forward Transfer Admittance vs Drain Current



Transient Thermal Response Curves

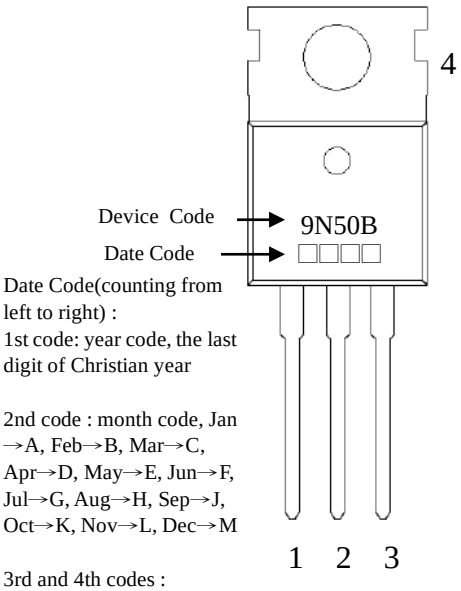


TO-220 Dimension



3-Lead TO-220 Plastic Package

Marking:



Date Code(counting from left to right) :
1st code: year code, the last digit of Christian year

2nd code : month code, Jan →A, Feb→B, Mar→C, Apr→D, May→E, Jun→F, Jul→G, Aug→H, Sep→J, Oct→K, Nov→L, Dec→M

3rd and 4th codes : production serial number, 01~99

Style: Pin 1.Gate 2.Drain 3.Source 4.Drain

DIM	Millimeters		Inches		DIM	Millimeters		Inches	
	Min.	Max.	Min.	Max.		Min.	Max.	Min.	Max.
A	4.400	4.600	0.173	0.181	e	2.540*		0.100*	
A1	2.250	2.550	0.089	0.100	e1	4.980	5.180	0.196	0.204
b	0.710	0.910	0.028	0.036	F	2.650	2.950	0.104	0.116
b1	1.170	1.370	0.046	0.054	H	7.900	8.100	0.311	0.319
c	0.330	0.650	0.013	0.026	h	0.000	0.300	0.000	0.012
c1	1.200	1.400	0.047	0.055	L	12.900	13.400	0.508	0.528
D	9.910	10.250	0.390	0.404	L1	2.850	3.250	0.112	0.128
E	8.950	9.750	0.352	0.384	V	7.500 REF		0.295 REF	
E1	12.650	12.950	0.498	0.510	Φ	3.400	3.800	0.134	0.150